

**Optical Arrangement and Projection Exposure System for
Microlithography with Passive Thermal Compensation**

Cross-References to Related Applications

[0001] This application is a Continuation in Part of Patent Application 09/255,137 of the same inventors, the priority of which is claimed for this application.

Statement Regarding Federally Sponsored Research or Development
Not applicable.

Background of the Invention

Field of the Invention

[0002] This invention relates to an optical arrangement with a light source and an optical element, and more particularly to projection exposure systems for microlithography, in which a thermal effect that is not rotationally symmetrical that results from the irradiation from the light source is compensated. Microlithography notoriously is the art of producing structures in the micrometer and submicrometer range - inter alia for microelectronic devices - by photolithography.

[0003] This situation is of particular importance in wafer scanners with a slit-shaped image field: either a narrow rectangle slit with a width to length ratio of e.g. typically 1:5 to 1:9, or an arcuate shape, particularly in

mirror systems.

Discussion of Relevant Art

Sub B1

[0004] ~~Active compensation of the imaging errors resulting from asymmetric thermal effects is known from European Patent EP-A 0 678 768, by regulated or controlled non-rotationally-symmetrical heating or cooling and also, by way of a suggestion, by mechanical stressing.~~

[0005] The like was described earlier in European Patent EP-B1 0 532 236, preferably as heating for mirrors.

Summary of the Invention

[0006] The invention has as its object to markedly reduce or render symmetrical, by the simplest possible means, the change of the properties of optical elements due to light absorption and the resulting heating, particularly in projection exposure systems.

[0007] This object is achieved by an optical arrangement and by projection exposure systems having an optical arrangement with the following features:

[0008] An optical arrangement with a light source, that emits radiation, having a mount, and an optical element fastened in the mount. The optical element, is acted on by the radiation such that heat results from the radiation that lacks symmetry corresponding to the shape of the optical

illumination in a symmetrical mounting with a cooling body of non-rotationally-symmetrical shape;

[0015] Fig. 3b shows a section along section line IIIb-IIIb of Fig. 3a;

[0016] Fig. 3c shows a section along section line IIIc-IIIc Fig. 3a;

[0017] Fig. 4 shows schematically in cross section a variant with a cooling tab and heat conducting cable;

[0018] Fig. 5a shows a FEM model with symmetrically arranged like cooling bodies;

[0019] Fig. 5b shows schematically in cross section another variant with a cooling tab and heat conducting cable;

[0020] Fig. 6 shows a FEM model similar to Fig. 5a, but with the cooling body varied in position, size and material;

[0021] Fig. 7 shows a variant with a cooling body with temperature-induced variation of the cooling effect;

[0022] Fig. 8 shows, in schematic section, a mirror with different cooling effected by webs of different materials; and

[0023] Fig. 9 shows schematically a general view of a projection exposure system.

Detailed Description of Preferred Embodiments

[0024] The arrangement of Fig. 1 shows a lens mount 2 in which a lens

(only minimal mobility of the joints is required) takes place sufficiently effectively by means of the filling gas (helium) or by a flexible metal cable (stranded conductor) (see Fig. 6b).

[0030] The exact combination is established here also with the support of simulation calculations. A combination with the use of different materials as shown in Fig. 1 opens up wider possibilities of matching.

[0031] Additionally, a "dipole" illumination of the lens with two eccentric light spots 101, 102 is shown in this Fig. 2, as occurs in the region of the diaphragm plane and equivalent planes of projection exposure systems with symmetrical oblique illumination. Astigmatic errors due to light absorption also arise therewith, and can be reduced by passive compensating cooling.

[0032] Figs. 3a-3c show a variant of the invention with an additional thermally conducting element 3, which is provided only for the equalizing cooling.

[0033] The lens 1 and mount 2 are in this case connected with uniform webs or with selectively cooling webs according to Figs. 1 or 2. Any other mounting technique is likewise usable.

[0034] The thermally conducting element 3 is connected fast to the mount 2 with good thermal conduction, and covers portions of the lens 1

through which no light passes and which are thus outside the illuminated surface 10, also shown here as a slit.

[0035] This covering is preferably free from contact, at a spacing of about 0.1 mm, so that a good thermal transfer is assured by means of the filling gas, but no stresses can be transmitted into the lens 1. Better thermal conduction of course results when the gap between the lens 1 and the thermally conducting element 3 is filled with adhesive, a gel, liquid crystals, or the like material which transmits as little stress as possible.

[0036] The thermal conduction and its local distribution is set by the shape of the thermally conducting part 3; Fig. 3b shows how the part 3 extends to the neighborhood of the illuminated region 10 in the direction A-A of the length of the slit, and Fig. 3c shows that the distance is kept large in the transverse direction B-B.

[0037] With the embodiment shown in Fig. 3a of the thermally conducting element 3, with numerous fingers or spokes, their width, shape, and distribution can be made use of for the adjustment of the thermal conduction. In an embodiment as an unbroken disk or as a perforated diaphragm, the thickness of the thermally conducting element can be locally different. It is also possible to make the individual fingers, analogously to the webs 21-28 of Fig. 1, of different thermally conducting

materials. The thermally conducting element 3 can of course also be arranged on both sides of the lens 1.

[0038] Fig. 4 shows, in an illustration corresponding to Fig. 3b, a manner in which the cooling element 3 can be brought into material contact or shape-fitting contact with the lens 1 without impairing the mechanical properties of the mount 2 and the connecting portions 21. For this purpose, the cooling element 3 is provided with a flexible, heat-conducting cable 30 - e.g., a stranded copper wire - and is connected to a heat sink 20.

[0039] Fig. 5a shows in plain view the finite element model of a quadrant of a lens 1 of quartz glass (middle thickness 14.4 mm, upper radius of curvature 1600 mm, lower radius of curvature 220 mm, biconvex, diameter 160 mm). Eight solid tabs (51, 52, 53) of aluminum are uniformly distributed, arranged on the lens 1 in the manner which will be apparent from the cross section, Fig. 5b. They are 30 mm wide, 2 mm thick above the lens and covering it for 6 mm radially, outside which they are a further 8 mm long radially, with a thickness of 4 mm. At the outer edge, they are kept to the base temperature by flexible, thermally conductive stranded wires 50, for example.

[0040] The displayed surface of the lens 1 is exposed to an introduction

of 1 W/cm^2 of heat by light absorption in the region 4, which approximates to about a right angle in the selected element division. The temperature increase in the middle point then reaches 7.6 milli-degrees. The isotherms 0.1-0.9 are shown drawn in and indicate the course of the lines with the corresponding fraction of this temperature increase. With a higher introduction of heat, the temperature increase is linearly scaled over a wide range.

[0041] It is quite evident that in this embodiment with a symmetrical cooling arrangement, to be counted as prior art, the temperature distribution which is obtained is distributed with marked asymmetry over the whole lens.

[0042] In the embodiment according to the invention, which is shown in Fig. 6, the cooling tabs situated on the Y-axis are omitted. The cooling tabs 510 situated on the X-axis are doubled in width and in addition are made of silver, which conducts heat better. The tabs 52 between remain unaltered, as likewise the heat supply in the region 4.

[0043] The temperature increase at the middle point now becomes 9.2 milli-degrees. The isotherms now show good rotational symmetry up to about 0.7 times the maximum temperature increase and to half the lens diameter.

specific thermal conductivity of their material (e.g., silver at the middle 74, lead 72, 76 at the edges 72, 76, and otherwise (73, 75) aluminum, and the outer edge 71, 77 of glass ceramics).

[0049] The different thermal expansion of the materials for the supports 71-77 can be used if necessary in order to compensate for deformations of the mirror 6 due to heating, or else to cause them in a targeted manner. In the latter case, disturbances of other optical elements which cooperate in a system with the mirror 6 can be compensated.

[0050] Fig. 9 shows, in a schematic overview, the complete optical system of a projection exposure system for microlithography. A DUV excimer laser serves as the light source 61. A beam-forming optics 62 with zoom axicon objective 63 an optional diaphragm 64 (e.g. variable, conventional, ring aperture, dipole aperture, quadrupole aperture) and a homogenizing quartz rod 65 illuminates the REMA diaphragm 66, which is imaged by the following REMA objective 67 as a sharp-edged homogeneous light spot, in particular as a narrow scanning slit, on the mask 68.

[0051] The following reducing projection objective 69 images the mask 68 onto the wafer 70. The lenses 671 and 672 of the REMA objective 67 and 692 of the projection objective 69 are situated in near field planes and

therefore are now preferred optical elements on which the cooling according to the invention is used. This cooling reduces the imaging errors arising due to the narrow slit-shaped illuminated field in a scanner in which the mask 68 and wafer 70 are synchronously scanned.

[0052] The lens 691 is arranged nearest the aperture diaphragm 690 of the projection objective 69. It is specially strained by special kinds of illumination, for example, a dipole aperture (see Fig. 2). However, this disturbance can also be reduced by the asymmetric cooling according to the invention.

[0053] It is clear that the description of the Figures only describes examples for the invention. In particular, multifarious combinations of the described features are possible according to the invention, and the cooling can be adjustably embodied, in order to adjust, to adapt to changes, and so on.